

Programmable Array Logic (PAL®) 24-Pin Medium PAL Series -7, -5, and -4

General Description

The 24-pin medium PAL family contains four of the most popular PAL architectures with speeds as fast as 4.5 ns maximum propagation delay. Series -7, -5 and -4 devices are manufactured using National Semiconductor's proprietary ASPECT™ II TTL process with highly reliable "verticalfuse" programmable cells. Vertical fuses are implemented using avalanche-induced migration (AIMTM) technology offering very high programming yields and is an extension of National's FAST® logic family. The 24-pin medium PAL family provides high-speed user-programmable replacements for conventional SSI/MSI logic with significant chip-count reduction.

Programmable logic devices provide convenient solutions for a wide variety of application-specific functions, including random logic, custom decoders, state machines, etc. By programming the programmable cells to configure AND/OR gate connections, the system designer can implement custom logic as convenient sum-of-products Boolean functions. System prototyping and design iterations can be performed quickly using these off-the-shelf products. A large variety of programming units and software makes design development and functional testing of PAL devices quick and easy.

The PAL logic array has a total of 20 complementary input pairs and 8 outputs generated by a single programmable AND gate array with fixed OR-gate connections. Device outputs are either taken directly from the AND-OR functions (combinatorial) or passd through D-type flip-flops (regis-

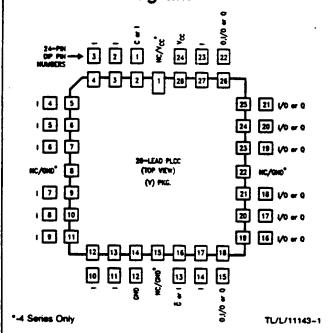
tered). Registers allow the PAL device to implement sequential logic circuits. TRI-STATE® outputs facilitate busing and provide bidirectional I/O capability. The medium PAL family offers a variety of combinatorial and registered output

On power-up series -7, -5 and -4 devices reset all registers to simplify sequential circuit design and testing, direct register preload is also provided to facilitate device testing. Security fuses can be programmed to prevent direct copying of proprietary logic patterns.

Features

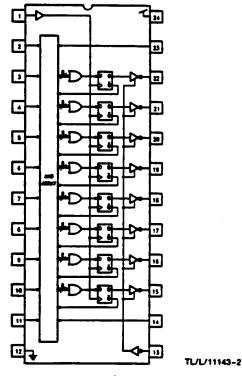
- 4.5 ns maximum propagation delay (combinatorial (atuatuo
- Pin compatible with existing PAL families
- High programming yield and reliability of vertical-fuse AIM technology
- Supported by industry standard programming equipment and design development software
- Fully supported by National PLAN™ software
- Power-up reset for registered outputs
- Register preload facilitates device testing
- User programmable replacement for high speed TTL
- Security fuse prevents direct copying of logic patterns
- High noise immunity DIP package

28-Lead PLCC Connection Conversion Diagram



FAST®, PAL® and TRI-STATE® are regis AIMI'M, ASPECTIM II and PLANIM are traden

Block Diagram—PAL20R8



Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{CC}) (Note 2)

-0.5V to +7.0V

Input Voltage (Note 2)

-1.5V to +7.0V

Off-State Output Voltage (Note 2) Input Current (Note 2)

-1.5V to +5.5V

Output Current (IOL)

-30 mA to +5.0 mA

+ 100 mA

Storage Temperature

-65°C to +150°C

Ambient Temperature with

Power Applied

-65°C to +125°C

Junction Temperature

-65°C to +150°C

2000V

ESD Tolerance (Note 3)

C_{ZAP} = 100 pF

 $R_{ZAP} = 1500\Omega$

Test Method: Human Body Model

Test Specification: NSC SOP-5-028

Recommended Operating Conditions

Symbol	Para	meter	-7	Commerc	ial	-7 Military			Units	
			Min	Nom	Max	Min	Nom	Max	Units	
Vœ	Supply Voltage		4.75	5	5.25	4.5	5	5.5	٧	
TA	Operating Free-Air Temperature		0	25	75	-5 5		125	•c	
tw	Clock Pulse Width	Low	4			5			ns	
		High	4			5			ns	
t su	Setup Time from Input or Feedback to Clock		6.5			7			ns	
tн	Hold Time of Input af	ter Clock	0			0			ns	
fCLK	Clock Frequency	With Feedback			77			74	MHz	
	(Note 4) Without Feedbac				125			100	MHz	
Vz	Register Preload Cor	ntrol Voltage	9.5	9.75	10.0	9.5	9.75	10.0	٧	

Electrical Characteristics Over Recommended Operating Conditions (Note 5)

Symbol	Parameter		Test Conditions	Min	Тур	Max	Unite	
V _{IL}	Low Level Input Voltag	je (Note 6)				8.0	٧	
V _{IH}	High Level Input Volta	ge (Note 6)		2			٧	
V _{IC}	Input Clamp Voltage		V _{CC} = Min, I = -18 mA			-1.2	٧	
I _{IL}	Low Level Input Curre	nt (Note 7)	$V_{CC} = Max, V_1 = 0.4V$			-250	μΑ	
1 _{IH}	High Level Input Curre	nt (Note 7)	$V_{CC} = Max, V_I = 2.4V$			25	μΑ	
l _i	Maximm Input Current		$V_{CC} = Max, V_I = 5.5V$			100	μΑ	
VOL	Low Level Output Volta	age	V _{CC} = Min, I _{OL} = 24 mA			0.5	V	
VoH	High Level Output Volt	age	$V_{CC} = Min, I_{OH} = -3.2 \text{ mA}$	2.4			٧	
lozl	Low Level Off-State Output Current (Note 7)		$V_{CC} = Max, V_{O} = 0.4V$			-50	μΑ	
Гохн	High Level Off State O Current (Note 7)	utput	V _{CC} = Max, V _O = 2.4V			50	μА	
los	Output Short-Circuit	Comm	$V_{CC} = 5.0V, V_{O} = 0.5V$	-50		-130		
	Current (Note 8)	Mil	$V_{CC} = 5.5V, V_{O} = 0.5V$	-50		-200	mA	
lcc	Supply Current		V _{CC} = Max, Outputs Open		125	210	mA	
Cı	Input Capacitance		$V_{CC} = 5.0V, V_i = 2.0V$		5		pF	
င္၀	Output Capacitance		$V_{CC} = 5.0V, V_{O} = 2.0V$		6		pF	
C _{I/O}	I/O Capacitance		$V_{CC} = 5.0V, V_{I/O} = 2.0V$		6		pF	

Electrical Characteristics Over Recommended Operating Conditions (Continued)

Note 1: Absolute maximum ratings are those values beyond which the device may be permanently damaged. Proper operation is not guaranteed outside the specified recommended operating conditions.

Note 2: Some device pins may be raised above these limits during programming and preload operations according to the applicable specification.

Note 3: Vo must not exceed Voc + 1V.

Note 4: f_{CLK} with feedback is derived as $(t_{CLK}+t_{SU})=1$. f_{CLK} without feedback is derived as $(2t_w)=1$.

Note 5: All typical values are for $V_{CC} = 5.0V$ and $T_A = 25^{\circ}C$.

Note 6: These are absolute voltages with respect to the ground pin on the device and include all overshoots due to system and/or tester noise. Do not attempt to test these values without suitable equipment.

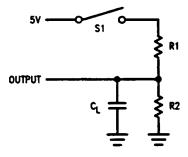
Note 7: Leakage current for bidirectional I/O pins is the worst case between I_H and I_{OZL} or between I_H and I_{OZL}

Note 8: To avoid invalid readings in other parameter tests it is preferable to conduct the I_{OS} test last. To minimize internal heating, only one output should be shorted at a time with a maximum duration of 1.0 sec. each. Prolonged shorting of a high output may raise the chip temperature above normal and permanent damage may result.

Switching Characteristics Over Recommended Operating Conditions

Symbol	Parameter	7.	est Conditions	-70	Commo	ercial	-	7 Milita	ary	Units
Symbol	rarameter	"	rst Conditions	Min	Тур	Max	Min	Тур	Max	J.,10
t _{PD}	Input or Feedback to	C _L = 50 pF,	4 Output Switching (DIP)			7				ns
	Combinatorial Output	S1 Closed	8 Output Switching (DIP)			7			7.5	ns
		PL	PLCC			7				ns
talk	Clock Input to Registered, Output or Feedback	C _L = 50 pF, S1 Closed				6.5			6.5	ns
t PZXG	G Pin to Registered Output Enabled	C _L = 50 pF, Active High: S1 Open, Active Low: S1 Closed				7			7.5	ns
t _P XZG	G Pin to Registered Output Disabled	C _L = 5 pF, From V _{OH} : S1 Open, From V _{OL} : S1 Closed				7			7.5	ns
₽ ZXI	Input to Combinatorial Output Enabled via Product Term		C _L = 50 pF, Active High: S1, Open, Active Low: S1 Closed			7			7.5	ns
^t PXZI	Input to Combinatorial Output Disabled via Product Term	C _L = 5 pF, From V _{OH} : S1 Open, From V _{OL} : S1 Closed				7			7.5	ns
^t RESET	Power-Up to Registered Output Low		360			1000			1000	ns

Test Load



TL/L/11143-3

MIL

COMM

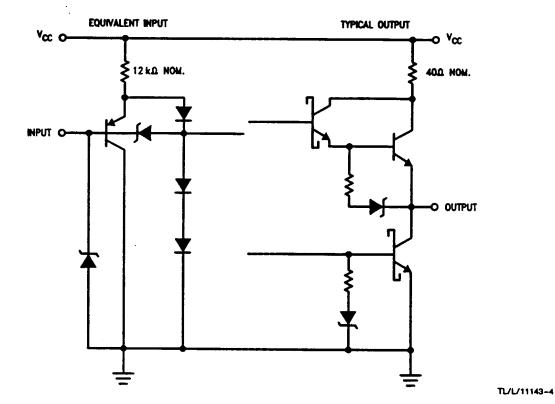
 $R1 = 390\Omega$

R1 = 200Ω

R2 = 750Ω

R2 = 390Ω

Schematic of Inputs and Outputs



-

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{CC}) (Note 2)

-0.5V to +7.0V

Input Voltage (Note 2)

-1.5V to +7.0V

Off-State Output Voltage (Note 2)
Input Current (Note 2)

-1.5V to +5.5V

Output Current (I_{OL})

-30 mA to +5.0 mA

+ 100 mA

Storage Temperature

-65°C to +150°C

Ambient Temperature with

Power Applied

-65°C to +125°C

Junction Temperature

-65°C to +150°C

ESD Tolerance (Note 3)

 $C_{ZAP} = 100 pF$ $R_{ZAP} = 1500\Omega$

Test Method: Human Body Model

Test Specification: NSC SOP-5-028

Recommended Operating Conditions

Symbol	Parai	meter	-5	Commerc	ial	-4 Commercial			Units
	. 2.2.110101		Min	Nom	Max	Min	Nom	Max	Units
Voc	Supply Voltage		4.75	5	5.25	4.75	5	5.25	٧
TA	Operating Free-Air Temperature		0	25	75	0	25	75	•c
tw	Clock Pulse Width	Low	4			4			ns
		High	4			4			ns
tsu	Setup Time from Input or Feedback to Clock		4			4			ns
tн	Hold Time of Input af	ter Clock	0			0			ns
fcLK	Clock Frequency	With Feedback			111			118	MHz
	(Note 4)	Without Feedback			125			125	MHz
VZ	Register Preload Cor	ntrol Voltage	9.5	9.75	10.0	9.5	9.75	10.0	V

Electrical Characteristics Over Recommended Operating Conditions (Note 5)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
V _{IL}	Low Level Input Voltage (Note 6)				0.8	٧
VIH	High Level Input Voltage (Note 6)		2			٧
V _{IC}	Input Clamp Voltage	V _{CC} = Min, I = -18 mA			-1.2	٧
IL	Low Level Input Current (Note 7)	$V_{CC} = Max, V_I = 0.4V$			-250	μΑ
I _{IH}	High Level Input Current (Note 7)	$V_{CC} = Max, V_1 = 2.4V$			25	μА
h	Maximum Input Current	$V_{CC} = Max, V_1 = 5.5V$			100	μА
V _{OL}	Low Level Output Voltage	V _{CC} = Min, I _{OL} = 24 mA			0.5	٧
V _{OH}	High Level Output Voltage	$V_{CC} = Min, I_{OH} = -3.2 \text{ mA}$	2.4			٧
lozu	Low Level Off-State Output Current (Note 7)	$V_{CC} = Max, V_O = 0.4V$			-50	μА
ЮZН	High Level Off State Output Current (Note 7)	V _{CC} = Max, V _O = 2.4V			50	μА
los	Output Short-Circuit Current (Note 8)	$V_{CC} = 5.0V, V_{O} = 0.5V$	-50		-130	mA
lα	Supply Current	V _{CC} = Max, Outputs Open		125	210	mA
Cı	Input Capacitance	$V_{CC} = 5.0V, V_{I} = 2.0V$		5		ρF
Co	Output Capacitance	$V_{CC} = 5.0V, V_{O} = 2.0V$		6		рF
C _{I/O}	I/O Capacitance	$V_{CC} = 5.0V, V_{I/O} = 2.0V$		6		pF

Electrical Characteristics Over Recommended Operating Conditions (Continued)

Note 1: Absolute maximum ratings are those values beyond which the device may be permanently damaged. Proper operation is not guaranteed outside the specified recommended operating conditions.

Note 2: Some device pins may be raised above these limits during programming and preload operations according to the applicable specification.

Note 3: Vo must not exceed Voc + 1V.

Note 4: I_{CLK} with feedback is derived as $(I_{CLK} + I_{SU})^{-1}$. I_{CLK} without feedback is derived as $(2 I_W)^{-1}$.

Note 5: All typical values are for $V_{\rm CC}$ = 5.0V and $T_{\rm A}$ = 25°C.

Note 6: These are absolute voltages with respect to the ground pin on the device and include all overshoots due to system and/or tester noise. Do not attempt to test these values without suitable equipment.

Note 7: Leakage current for bidirectional I/O pins is the worst case between I_{kl} and I_{OZI}, or between I_{kl} and I_{OZI}.

Note 6: To avoid invalid readings in other parameter tests it is preferable to conduct the lost test last. To minimize internal heating, only one output should be shorted at a time with a maximum duration of 1.0 sec. each. Prolonged shorting of a high output may raise the chip temperature above normal and permanent demage may result.

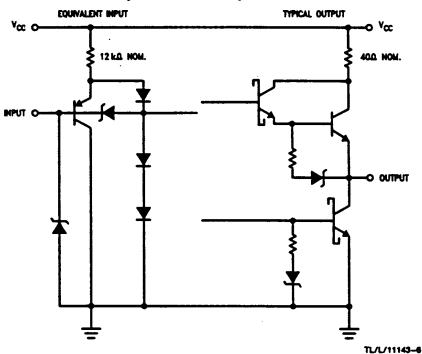
Switching Characteristics Over Recommended Operating Conditions

Symbol	Parameter	T	est Conditions	-50	Commo	ercial	40	Units		
	Talinoto:				Тур	Max	Min	Тур	Max	O.H.C
t PD	Input or Feedback to	$C_L = 50 pF$,	4 Output Switching (DIP)			5				ns
	Combinatorial Output	S1 Closed	8 Output Switching (DIP)			5.5				ns
		PLC	PLCC			5			4.5	ns
tcux	Clock Input to Registered Output or Feedback	C _L = 50 pF, S1 Closed				5			4.5	ns
t PZXG	G Pin to Registered Output Enabled	C _L = 50 pF, Active High: S1 Open, Active Low: S1 Closed				5			4.5	ns
t PXZG	G Pin to Registered Output Disabled	C _L = 5 pF, From V _{OH} : S1 Open, From V _{OL} : S1 Closed				5			4.5	ns
t PZXI	Input to Combinatorial Output Enabled via Product Term	C _L ≈ 50 pF, Active High: S1, Open, Active Low: S1 Closed				5			4.5	ns
t PXZI	Input to Combinatorial Output Disabled via Product Term	C _L = 5 pF, From V _{OH} : S1 Open, From V _{OL} : S1 Closed				5		4	4.5	ns
^t RESET	Power-Up to Registered Output Low	3600.0000				1000			1000	ns

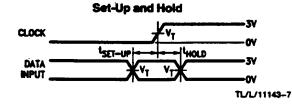
Test Load

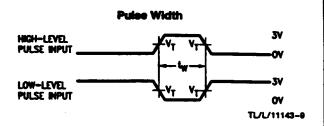
R1 = 200Ω R2 = 200Ω

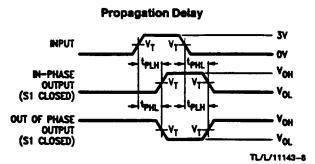
Schematic of Inputs and Outputs

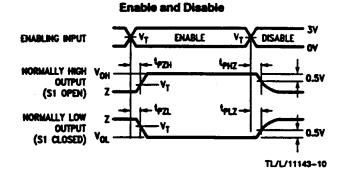


Test Waveforms









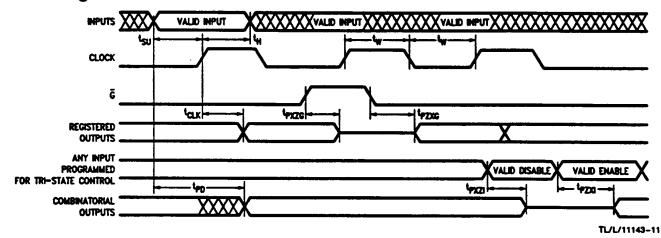
Notes:

 $V_T = 1.5V$

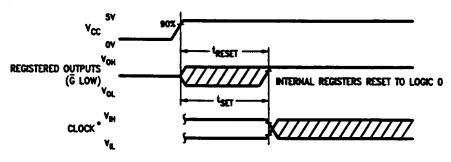
C_L includes probe and jig capacitance.

in the examples above, the phase relationships between inputs and outputs have been chosen arbitrarily.

Switching Waveforms



Power-Up Set/Reset Waveform



"The clock input should not be switched from low to high until after time treeser or teer.

TL/L/11143-12

Functional Description

All of the 24-pin medium PAL logic arrays consist of 20 complementary input lines and 64 product-term lines with a programmable cell at each intersection (2560 cells). The product terms are organized into eight groups of eight each. Seven or eight of the product terms in each group connect into an OR-gate to produce the sum-of-products logic function, depending on whether the output is combinatorial or registered.

In the National Series -7, -5 and -4 vertical fuse (AIM) PAL devices, a programmed vertical fuse cell establishes a connection between an input line and a product term. A product term is satisified (logically true) while all of the input lines connected to it (via unprogrammed fuses for the fuse-link devices, or by programming the corresponding cells for the vertical fuse devices) are in the high logic state. Therefore, if both the true and complement of at least one array input is connected to a product line, that product term is always held in the low logic state (which is the state of all product terms in an unprogrammed fuse-link device). Conversely, if all input lines are disconnected from a product line, the product term and the resulting logic function would be held in the high state (which is the state of all product terms in an unprogrammed National -7, -5 and -4 PAL device). For more information on vertical fuse technology, consult our application note #594.

The medium PAL family consists of four device types with differing mixtures of combinatorial and registered outputs. The 20L8, 20R4, 20R6 and 20R8 architectures have 0, 4, 6 and 8 registered outputs respectively, with the balance of the 8 outputs combinatorial. All outputs are active-low and have TRI-STATE capability.

Each combinatorial output have a seven product-term logic function, with the eighth product term being used for TRI-STATE control. A combinatorial output is enabled while the TRI-STATE product term is satisfied (true). Combinatorial outputs also have feedback paths from the device pins into the logic array (except for two outputs on the 20LB). This allows a pin to perform bidirectional I/O or, if the associated TRI-STATE control product term were programmed to remain unsatisified (always false), the output driver would remain disabled and the pin could be used as an additional dedicated input.

Registered outputs each have an eight product-term logic function feeding into a D-type flip-flop. All registers are triggered by the high-going edge of the clock input pin. All registered outputs are controlled by a common output enable (G) pin (enabled while low). The output of each register is also fed back into the logic array via an internal path. This provides for sequential logic circuits (state machines, counters, etc.) which can be sequenced even while the outputs are disabled.

Series -7, -5 and -4 medium PAL devices reset all registers to a low state upon power-up (active-low outputs assume high logic levels if enabled). This may simplify sequential circuit design and test. To ensure successful power-up reset, V_{CC} must rise monotonically until the specified operating voltage is attained. During power-up, the clock input should assume a valid, stable logic state as early as possible to avoid interfering with the set or reset operation. The clock input should also remain stable until after the power-up reset operation is completed to allow the registers to capture the proper next state on the first high-going clock transition.

During power-up, all outputs are held in the high-impedance state until DC power supply conditions are met ($V_{\rm CC}$ approximately 3.0V), after which they may be enabled by the TRI-STATE control product terms (combinatorial outputs) or the $\overline{\rm G}$ pin (registered outputs). Whenever $V_{\rm CC}$ goes below 3V (at 25°C), the outputs are disabled as shown in Figure 1 below.

In an unprogrammed National Series -7, -5 and -4 PAL devices, no array inputs are connected to any product-term lines. Therefore, all combinatorial outputs would be enabled and driving low logic levels (after power-up is completed). All registers would still initialize to the low state, but would become permanently set (low-level outputs, if enabled) following the first clock transition.

As with any TTL logic circuits, unused inputs to a PAL device should be connected to ground, V_{OL} , V_{OH} , or resistively to V_{CC} . However, switching any input not connected to a product term or logic function has no effect on its output logic state.

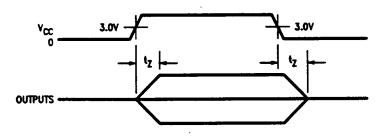
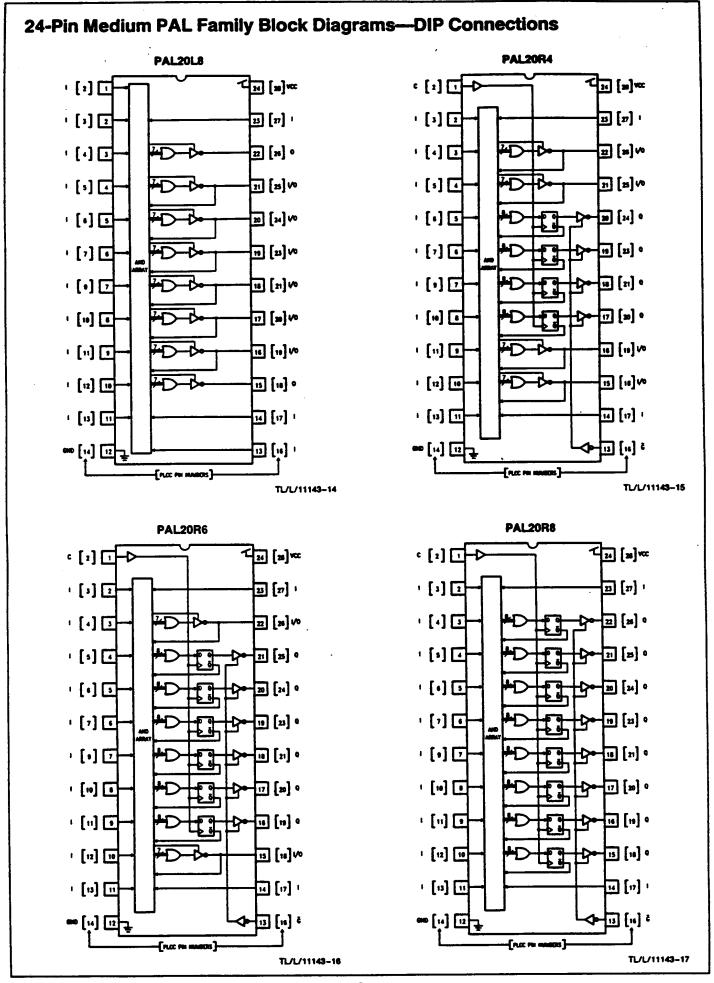


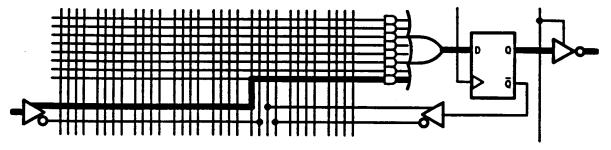
FIGURE 1. Power-Up TRI-STATE Waveform

TL/L/11143-13



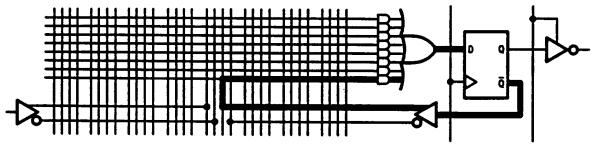
Functional Description (Continued)

Typical Registered Logic Function without Feedback



TUU11143-18

Typical Registered Logic Function with Feedback



TL/L/11143-19

Clock Frequency Specification

The clock frequency (fCLK) parameter specifies the maximum speed at which a registered PAL device is guaranteed to operate. Clock frequency is defined differently for the two cases in which register feedback is used versus when it is not. In a data-path type application, where the logic functions fed into the registers are not dependent on register feedback from the previous cycle (i.e., based only on external inputs) the minimum required cycle period (fCLK-1 without feedback) is defined as the greater of the minimum clock period (tw high + tw low) and minimum "data window" period (t_{SU} + t_H). This assumes optimal alignment between data inputs and the clock input. In sequential logic applications such as state machines, the minimum required cycle period (f_{CLK}-1 with feedback) is defined as t_{CLK} + tsu. This provides sufficient time for outputs from the registers to feed back through the logic array and set-up on the inputs to the registers before the end of each cycle.

Output Register Preload

This feature simplifies device testing since any state may be loaded into the registers at any time during the functional test sequence. This allows complete verification of sequential logic circuits, including states that are normally impossible or difficult to reach. Register preload is not an operational mode and is not intended for board level testing because elevated voltage levels are required. The programming system normally provides the preload capability as part of its functional test facility.

The preload function allows the registers to be loaded directly and asynchronously with any desired pattern. These vertical-fuse devices provide two register preload operations:

All registers can be reset to the low state (high-level outputs) by applying the elevated control voltage (V_Z) to input pin 2 for time t_D (Figure 2a).

- Selected registers can be set to the high state (low-level outputs) as follows (Figure 2b).
 - a. All registered outputs are disabled by raising $\overline{\mathbf{G}}$ input pin 1 to V_{IH} .
 - b. After time t_D, the selected registered output pins are raised to the elevated control voltage (V₂) for time t_D to set the corresponding register.

Security Fuse

Security fuses are provided on all National PAL devices which, when programmed, inhibit any further programming or verifying operations. This feature prevents direct copying of proprietary logic patterns. The security fuses should be programmed only after programming and verifying all other device fuses. Register preload is not affected by the security fuses.

Design Development Support

A variety of software tools and industry standard programming hardware is available to support the development of designs using PAL products. Typical software packages accept Boolean logic equations to define desired functions. Most are available to run on personal computers and generate JEDEC-compatible "fuse maps". The industry-standard JEDEC format ensures that the resulting fuse-map files can be down-loaded into a variety of programming equipment. Many software packages and programming units support a multitude of programmable logic products as well. PLAN software package from National Semiconductor supports all of our programmable logic products and is fully JEDEC-compatible.

Design Development Support (Continued)

In National Series -7, -5 and -4 devices, logical and physical connections between array input lines and product-term lines are established when vertical fuse cells are programmed. This is opposite to other PAL products based on fusible links in which connections are established when fuses are left unprogrammed (intact). This difference is compensated by the vertical-fuse PAL programming algorithm so that the user's design development process looks the same. (The only functional difference due to vertical-fuse technology is the behavior of "unprogrammed" devices.) The JEDEC programming maps produced by PAL development software for all Medium PAL devices denote a "connection" with a "o", and a "non-connection" with a "1". The programming algorithms for most fuse-link PLDs program fuses where ones are located in the map to remove corresponding connections, whereas the algorithm for National Series PAL -7, -5 and -4 products automatically compensates by programming vertical-fuse cells where zeroes are located in the map to establish connections. Therefore, the same JEDEC map representing the user's desired logic equations produces the same functional results when using either PAL technology. The user need only provide the appropriate device code and/or adapter for the programming equipment to invoke the proper programming algorithm. Only programmers with the certified National vertical-fuse PAL programming algorithm should be used to program these vertical-fuse devices.

Detailed logic diagrams showing all JEDEC fuse-map addresses for the 24-pin medium PAL family are provided for direct map editing and diagnostic purposes. The DIP and PLCC package for -7, -5 and -4 series are pin for pin replacements for all slower 24-pin medium PAL devices (A, B and D Series). The non-connected (NC) pins on the PLCC package are utilized in the -4 series as extra power and ground pins (V_{CC} and GND) to provide better noise immunity at high switching speeds. For a list of current software and programming support tools available for theses devices, please contact your local National Semiconductor sales representative or distributor. If detailed specifications of the PAL programming algorithm are needed, please contact the National Semiconductor Programmable Device Support Department.

Functional Description (Continued)

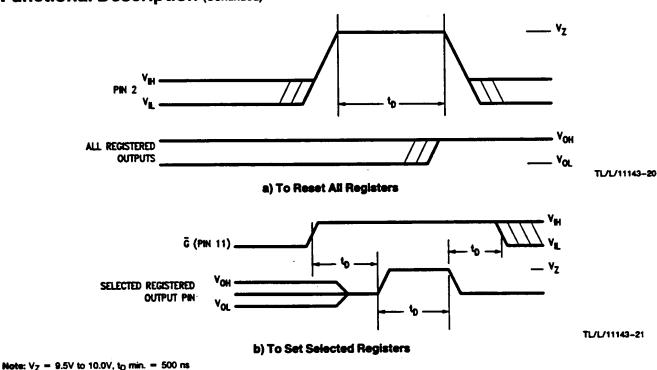
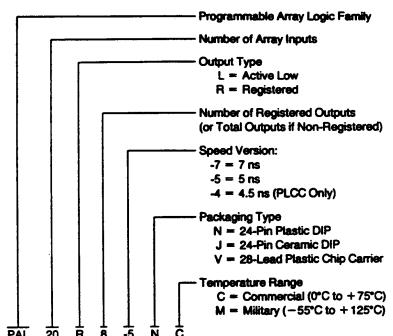
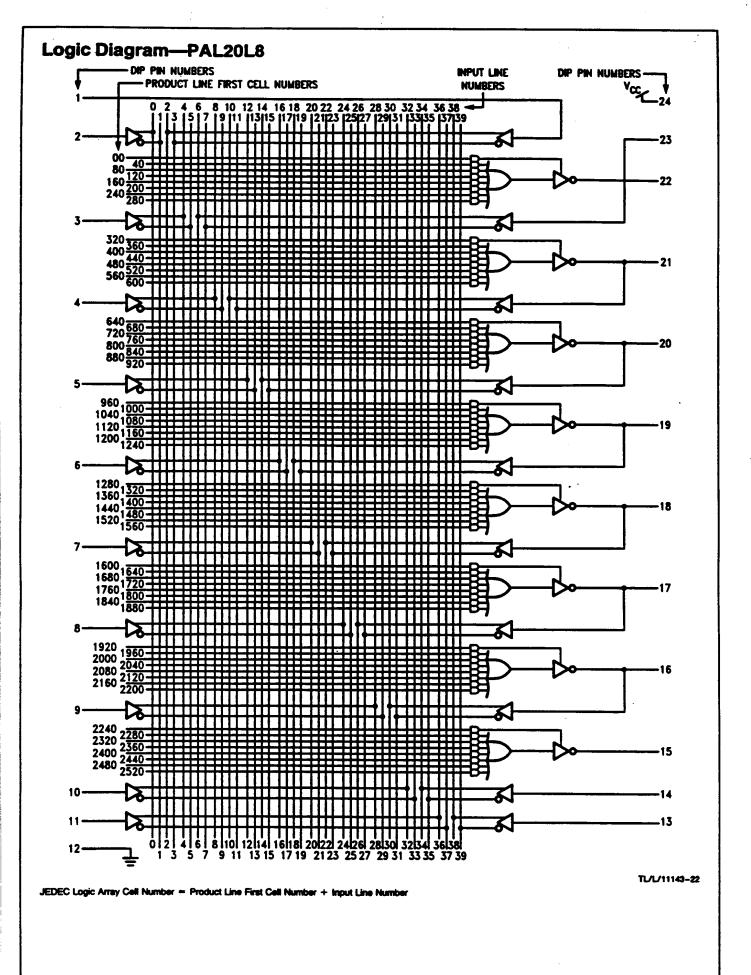
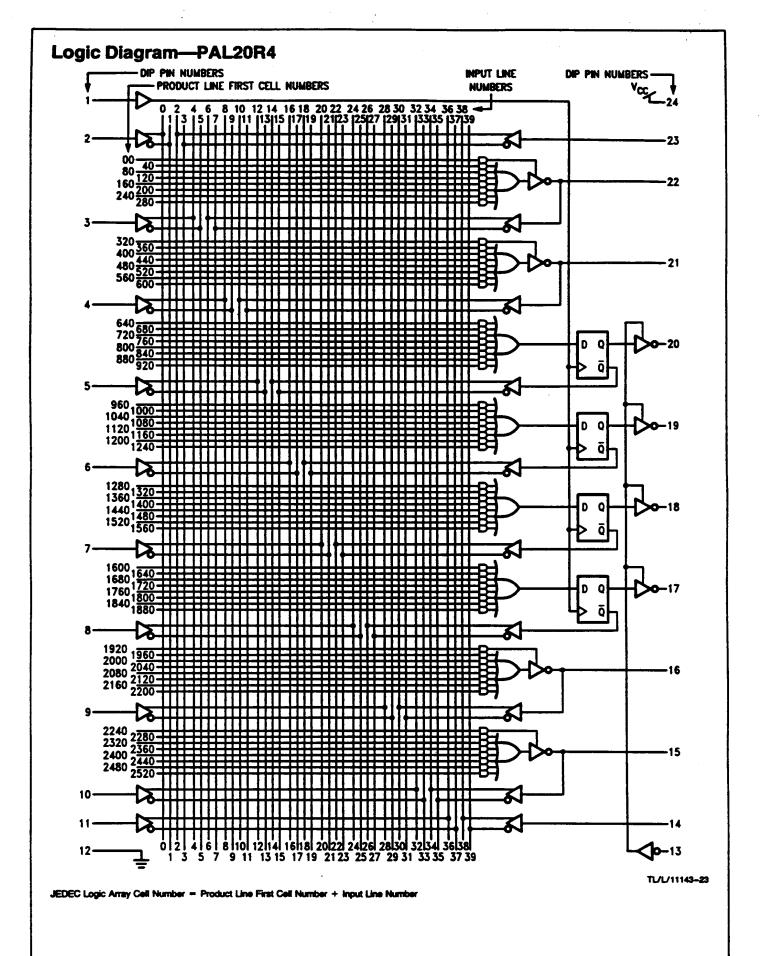


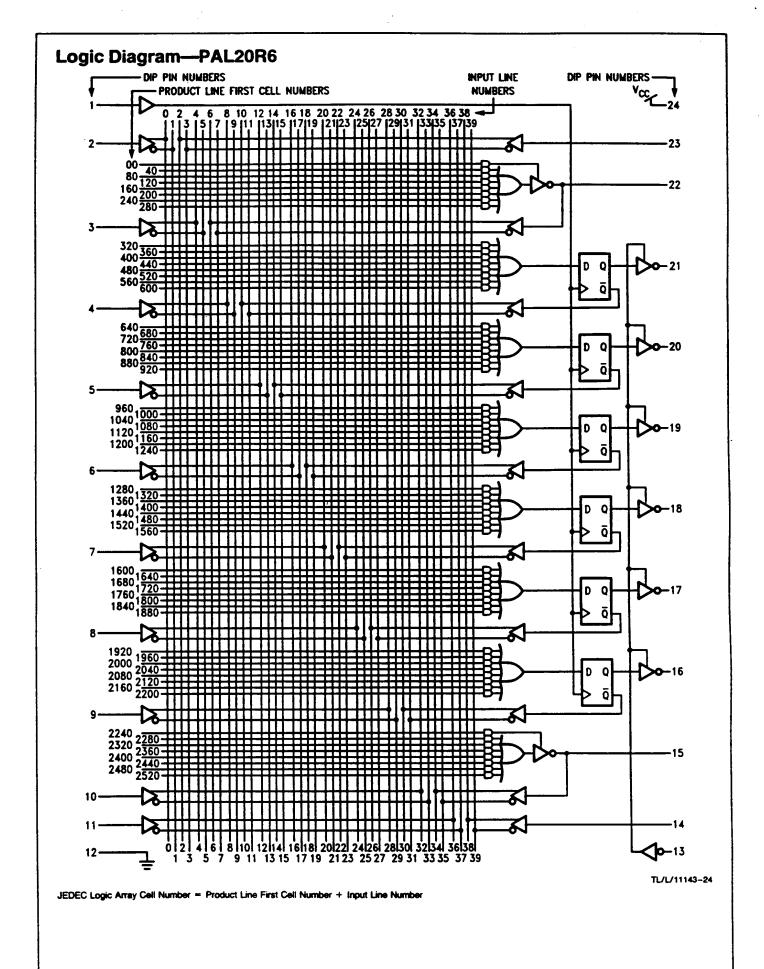
FIGURE 2. Register Preload Waveforms

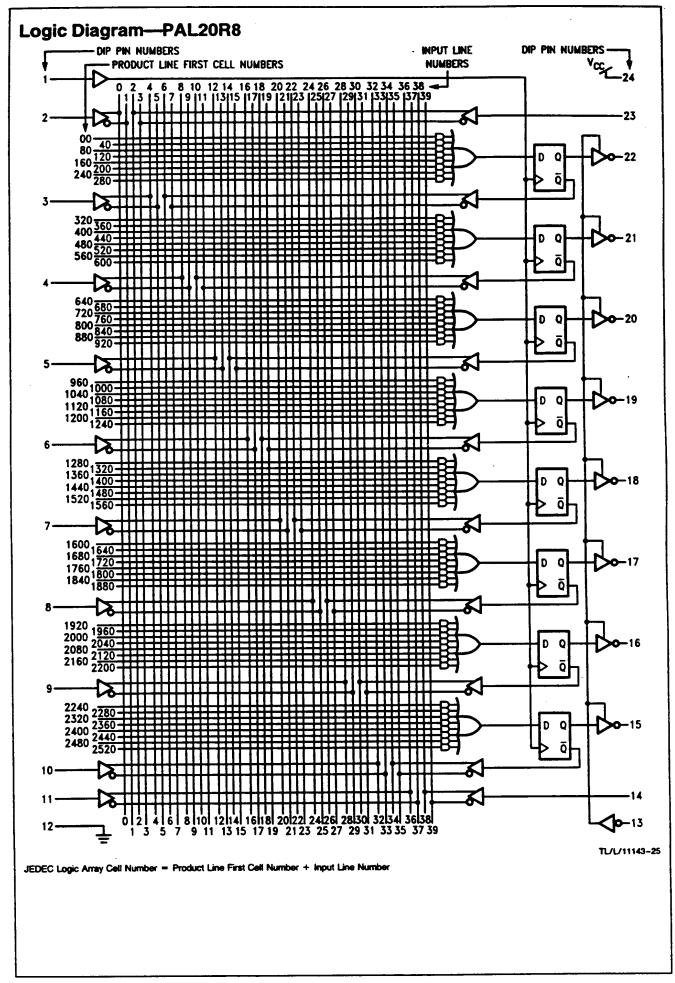


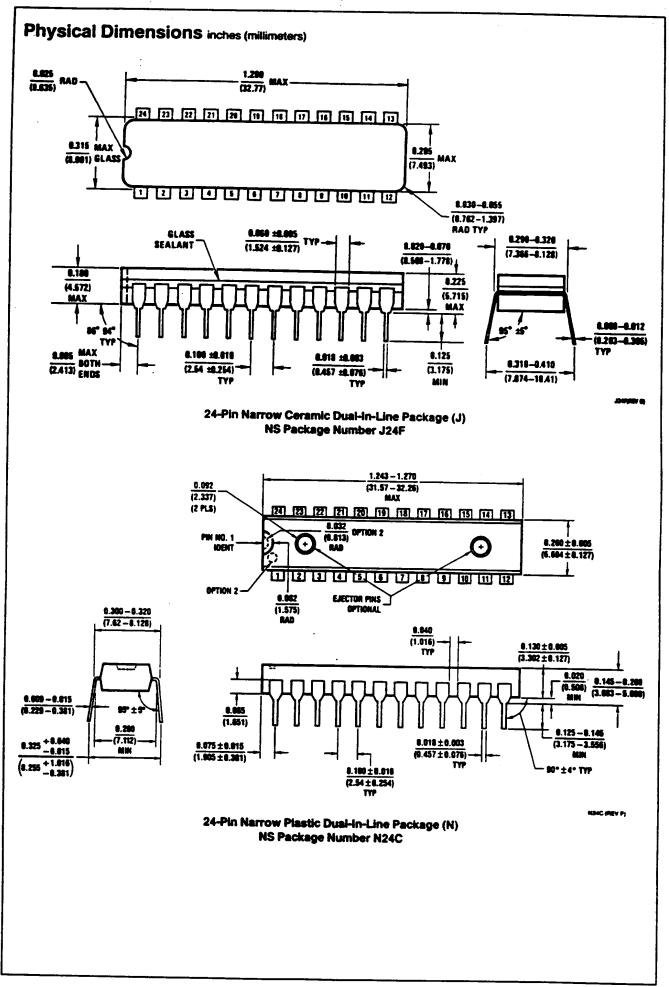




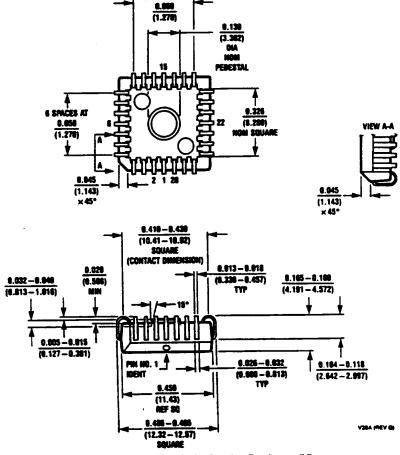








Physical Dimensions inches (millimeters) (Continued)



28-Lead Plastic Chip Carrier Package (V) NS Package Number V28A

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



Corporation 2900 Semiconductor Drive P.O. Box 59090 Sente Clere, CA 95052-8090 Tet. 1(800) 272-8059 TWX: (910) 339-8240 Hatland Bemicenducter GmbH Industriaatrasse 10 D-8080 Furstanfeldbruck West Germany Tel: (D-81-41) 103-0 Teles: 527-640 Fax: (08141) 103654 Japan Ltd. Semedo Bidg. SF 4-15 Niehi Shiriphia Shiriphia-Ku, Tokyo 160, Japan Tel: 3-290-7001 FAX: 3-290-7000 National Semiconduster
Hong Kong List.
Suite 513, 5th Floor
Chinachem Golden Plaza,
77 Mody Road, Trimehataui East,
Kowloon, Yong Kong
Tet: 3-7231280
Fales: 52980 NSSEA HX
Fac: 3-3112536

National Semiconduteres De Breef Lide. Av. Brig. Ferle Lime, 1383 6.0 Andor-Conj. 62 01451 Sao Paulo, SP, Breef Tel: (55/11) 212-5005 Fax: (55/11) 211-1181 NSBR BR Mattenal Semiconductor (Australia) PTY, Ltd. 1st Floor, 441 St. Kida Ri Melbourna, 3004 Victory, Australia Tel: (03) 267-8000 Fee: 61-3 2677450